

HCPL2730, HCPL2731 DUAL-CHANNEL OPTOCOUPLEDERS/OPTOISOLATORS

SOOS020 D3262, JUNE 1989

- Dual-Channel Optocouplers
- High Current Transfer Ratio . . . 1800% Typ at $I_f = 0.5 \text{ mA}$
- Low Input Current Requirement . . . 0.5 mA
- High-Speed Switching . . . 100 kbit/s Typ
- High Common-Mode Transient Immunity . . . 500 V/ μs Typ
- High-Voltage Electrical Insulation . . . 3000 V DC Min
- High Output Current Rating of 60 mA
- UL Recognized . . . File Number 65085

description

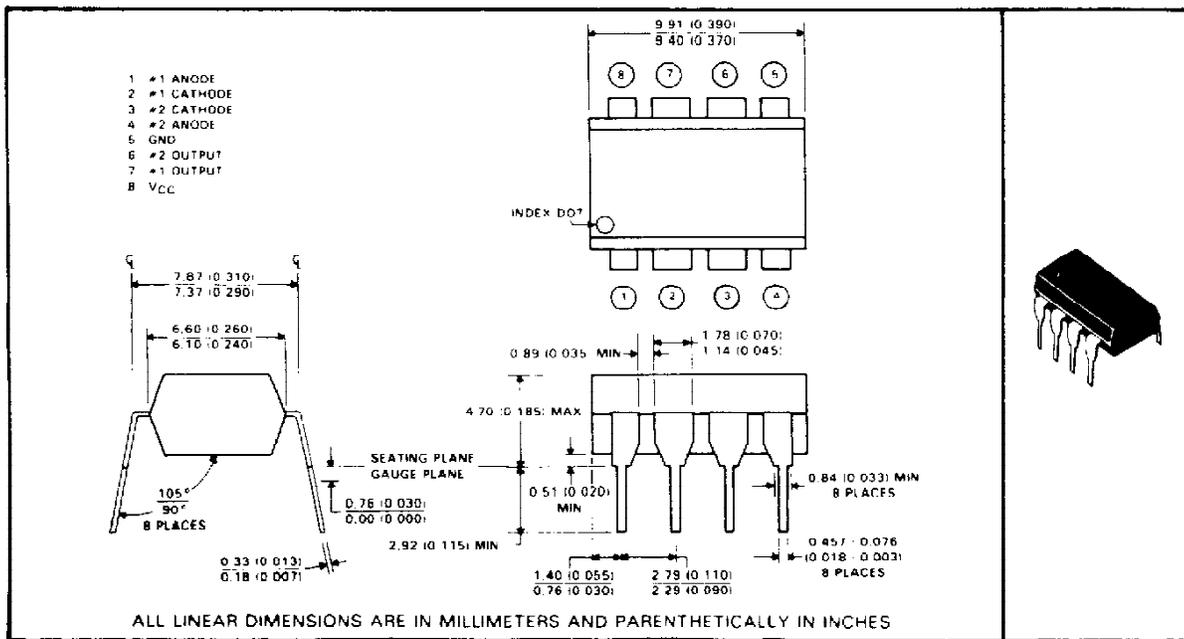
These devices are useful where large common-mode input signals exist, and in applications that require high-voltage isolation between circuits. Applications include line receivers, telephone ring detectors, power line monitors, high-voltage status indicators, and circuits that require isolation between input and output.

The HCPL2730 and HCPL2731 dual-channel high-gain optocouplers each consists of a pair of light-emitting diodes and integrated high-gain photon detectors. The VCC and output terminals may be tied together to achieve conventional photodarlington operation. An integrated emitter-base bypass resistor is provided for low leakage.

The HCPL2730 is designed for use primarily in TTL applications. An LED input current of 1.6 mA and a minimum current-transfer ratio of 300% from 0°C to 70°C allow operation with one TTL-load input and one TTL-load output utilizing a 2.2-k Ω pullup resistor.

The HCPL2731 is designed for use in CMOS, LSTTL, or other low-power applications. This device has a minimum current-transfer ratio of 400% for only 0.5-mA input current over an operating temperature range of 0°C to 70°C.

mechanical data



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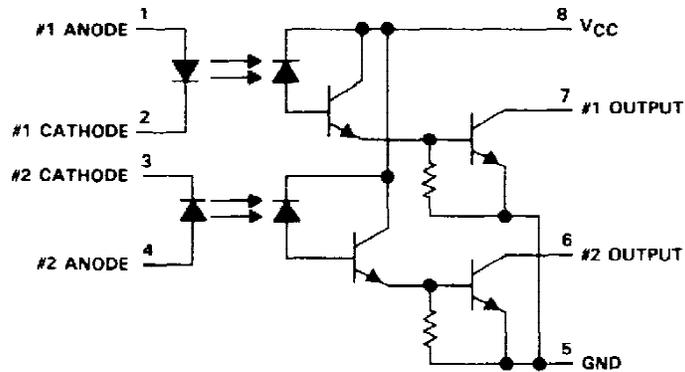
TEXAS
INSTRUMENTS

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HCPL2730, HCPL2731 DUAL-CHANNEL OPTOCOUPLERS/OPTOISOLATORS

schematic



absolute maximum ratings at 25°C free-air temperature range (unless otherwise noted)

Supply and output voltage range, V_{CC} and V_O : HCPL2730	-0.5 V to 7 V
HCPL2731	-0.5 to 18 V
Reverse input voltage	5 V
Peak input forward current per channel (pulse duration = 1 ms, 50% duty cycle)	40 mA
Average forward input current per channel at (or below) 50°C free-air temperature (see Note 1)	20 mA
Output current per channel at (or below) 35°C free-air temperature (see Note 2)	60 mA
Input power dissipation per channel at (or below) 50°C free-air temperature (see Note 3)	35 mW
Output power dissipation per channel at (or below) 35°C free-air temperature (see Note 4)	100 mW
Operating temperature range	-40°C to 85°C
Storage temperature range	-55°C to 125°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

- NOTES: 1. Derate linearly above 50°C free-air temperature at a rate of 0.67 mA/°C.
 2. Derate linearly above 35°C free-air temperature at a rate of 1.2 mA/°C.
 3. Derate linearly above 50°C free-air temperature at a rate of 1.0 mW/°C.
 4. Derate linearly above 35°C free-air temperature at a rate of 2.0 mW/°C.

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electrical characteristics over operating free-air temperature range of 0°C to 70°C (unless otherwise noted)

PARAMETER	TEST CONDITIONS	HCPL2730		HCPL2731		UNIT			
		MIN	TYP [†]	MAX	MIN		TYP [†]	MAX	
V _F	Input forward voltage	I _F = 1.6 mA, T _A = 25°C		1.5	1.7	1.5	1.7	V	
α _{VF}	Temperature coefficient of forward voltage	I _F = 1.6 mA		-1.8		-1.8		mV/°C	
V _{BR}	Input breakdown voltage	I _R = 10 μA, T _A = 25°C		5		5		V	
V _{OL}	Low-level output voltage	V _{CC} = 4.5 V, I _F = 1.6 mA, I _{OL} = 4.8 mA, I _B = 0		0.1		0.4		V	
		V _{CC} = 4.5 V, I _F = 1.6 mA, I _{OL} = 8 mA, I _B = 0				0.1			0.4
		V _{CC} = 4.5 V, I _F = 5 mA, I _{OL} = 15 mA, I _B = 0				0.1			0.4
		V _{CC} = 4.5 V, I _F = 12 mA, I _{OL} = 24 mA, I _B = 0				0.2			0.4
I _{OH}	High-level output current	V _{CC} = 7 V, V _O = 7 V, I _F = 0, I _B = 0		0.1		250		μA	
		V _{CC} = 18 V, V _O = 18 V, I _F = 0, I _B = 0				0.05			100
I _{CCH}	Supply current, high-level output	V _{CC} = 7 V, I _O = 0, I _F = 0, I _B = 0		4				nA	
		V _{CC} = 18 V, I _O = 0, I _F = 0, I _B = 0				5			
I _{CCL}	Supply current, low-level output	V _{CC} = 7 V, I _O = 0, I _{F1} = 1.6 mA, I _{F2} = 1.6 mA, I _B = 0		0.4				mA	
		V _{CC} = 18 V, I _O = 0, I _{F1} = 1.6 mA, I _{F2} = 1.6 mA, I _B = 0				0.6			
CTR	Current transfer ratio	V _{CC} = 4.5 V, V _O = 0.4 V, I _F = 0.5 mA, I _B = 0, See Note 5				400% 1800%			
		V _{CC} = 4.5 V, V _O = 0.4 V, I _F = 1.6 mA, I _B = 0, See Note 5		300% 1000%		500% 1600%			
r _{ii}	Input-input resistance	V _{ii} = 500 V		10 ¹¹		10 ¹¹		Ω	
r _{io}	Input-output resistance	V _{io} = 500 V, See Note 6		10 ¹²		10 ¹²		Ω	
I _{ii}	Input-input insulation leakage current	V _{ii} = 500 V, t = 5 s, RH = 45%		0.005		0.005		μA	
I _{io}	Input-output insulation leakage current	V _{io} = 3000 V, t = 5 s, T _A = 25°C, RH = 45%, See Note 6				1		μA	
C _i	Input capacitance	V _F = 0, f = 1 MHz		60		60		pF	
C _{ii}	Input-input capacitance	f = 1 MHz		0.25		0.25		pF	
C _{io}	Input-output capacitance	f = 1 MHz, See Note 6		0.6		0.6		pF	

[†]All typical values are at V_{CC} = 5 V, T_A = 25°C, unless otherwise noted.

NOTES: 5. Current transfer ratio is defined as the ratio of output collector current I_O to the forward LED input current I_F times 100%.

6. These parameters are measured between pins 2 and 3 shorted together and pins 5, 6, 7 and 8 shorted together.

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switching characteristics at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

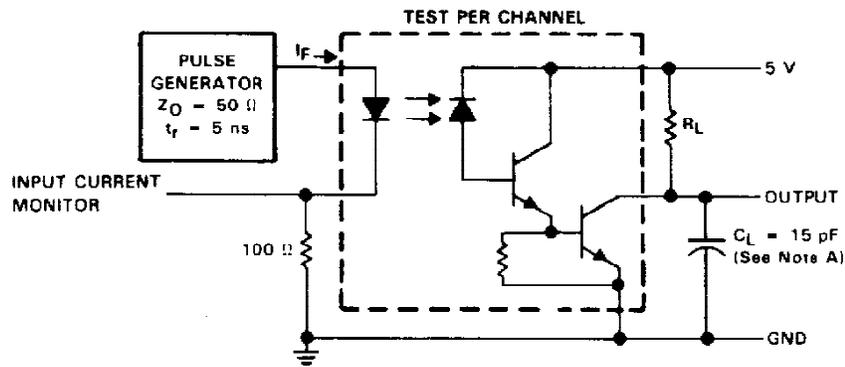
PARAMETER	TEST CONDITIONS	HCPL2730			HCPL2731			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
t_{PHL} Propagation delay time, high-to-low level output	$I_F = 1.6\text{ mA}$, $R_L = 2.2\text{ k}\Omega$, See Figure 1		2	20		2	20	μs
	$I_F = 0.5\text{ mA}$, $R_L = 4.7\text{ k}\Omega$, See Figure 1					7	100	
	$I_F = 12\text{ mA}$, $R_L = 270\ \Omega$, See Figure 1		0.4	2		0.4	2	
t_{PLH} Propagation delay time, low-to-high-level output	$I_F = 1.6\text{ mA}$, $R_L = 2.2\text{ k}\Omega$, See Figure 1		4	35		5	35	μs
	$I_F = 0.5\text{ mA}$, $R_L = 4.7\text{ k}\Omega$, See Figure 1					6	60	
	$I_F = 12\text{ mA}$, $R_L = 270\ \Omega$, See Figure 1		3	10		2	10	
$\frac{dV_{CM}}{dt}$ (H) Common-mode input transient immunity, high-level output	$V_{CM} = 10\text{ V}_{p-p}$, $I_F = 0$, $R_L = 2.2\text{ k}\Omega$, See Notes 7 and 8, See Figure 2		500			500		$\text{V}/\mu\text{s}$
$\frac{dV_{CM}}{dt}$ (L) Common-mode input transient immunity, low-level output	$V_{CM} = 10\text{ V}_{p-p}$, $I_F = 1.6\text{ mA}$, $R_L = 2.2\text{ k}\Omega$, See Figure 2 See Notes 7 and 8		-500			-500		$\text{V}/\mu\text{s}$

- NOTES: 7. Common-mode transient immunity, high-level output, is the maximum rate of rise of the common-mode input voltage that does not cause the output voltage to drop below 2 V. Common-mode input transient immunity, low-level output, is the maximum rate of fall of the common-mode input voltage that does not cause the output voltage to rise above 0.8 V.
8. In applications where dV/dt may exceed 50,000 $\text{V}/\mu\text{s}$ (such as static discharge) a series resistor, R_{CC} , should be included to protect the detector IC from destructively high surge currents. The recommended value is:

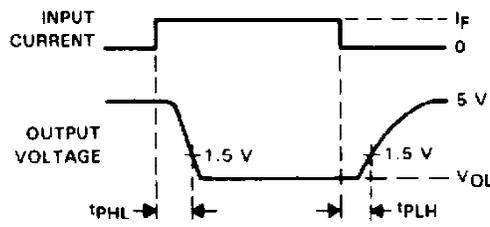
$$R_{CC} = \frac{1}{0.15 I_F (\text{mA})} \text{ k}\Omega$$

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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



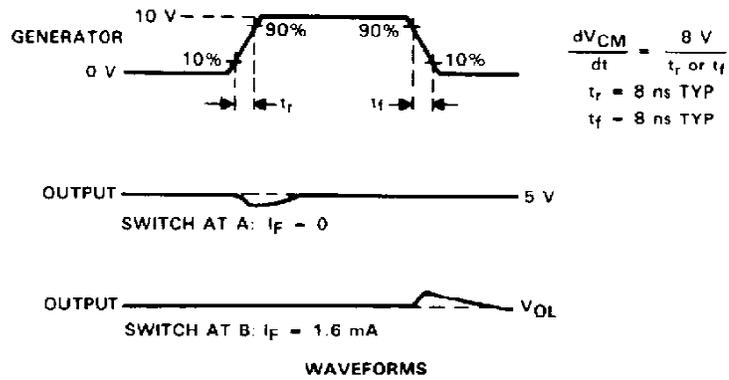
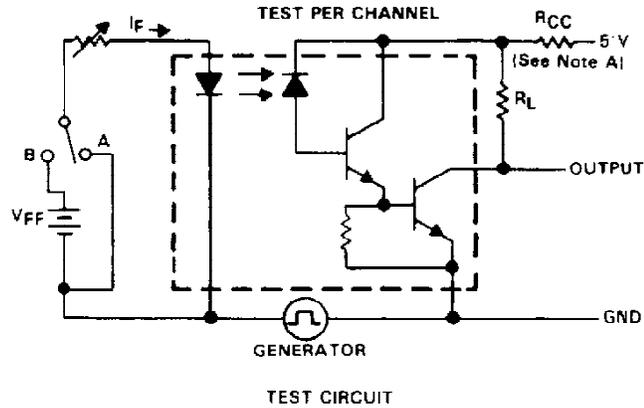
WAVEFORMS

NOTE A: C_L includes probe and stray capacitances.

FIGURE 1. SWITCHING TEST CIRCUIT AND WAVEFORMS

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PARAMETER MEASUREMENT INFORMATION



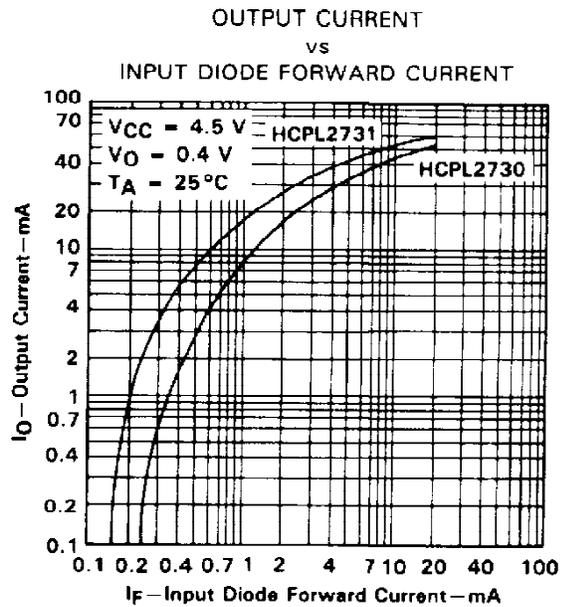
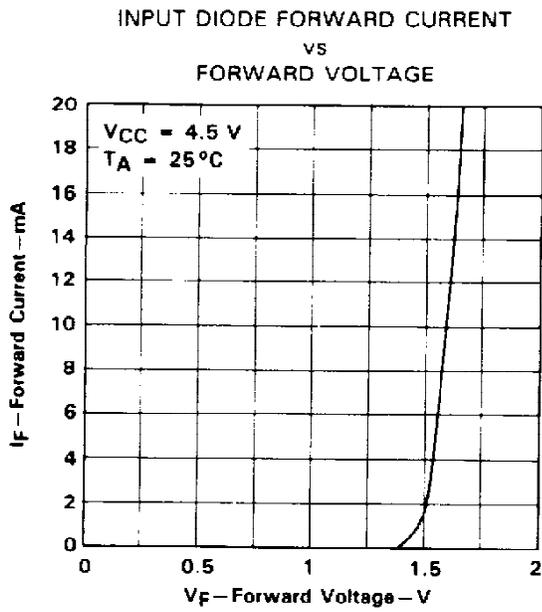
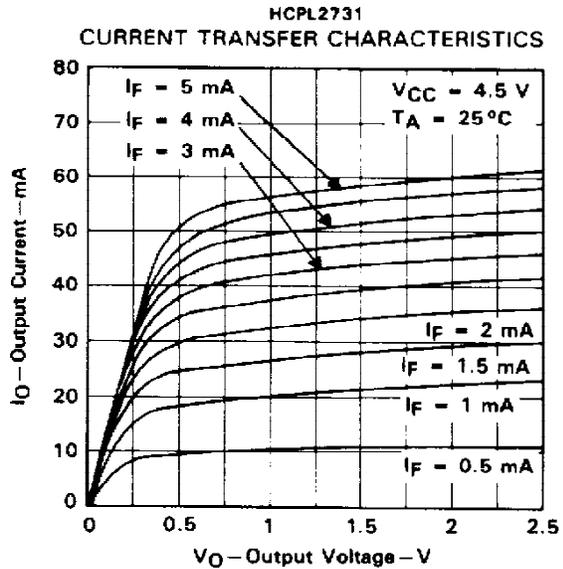
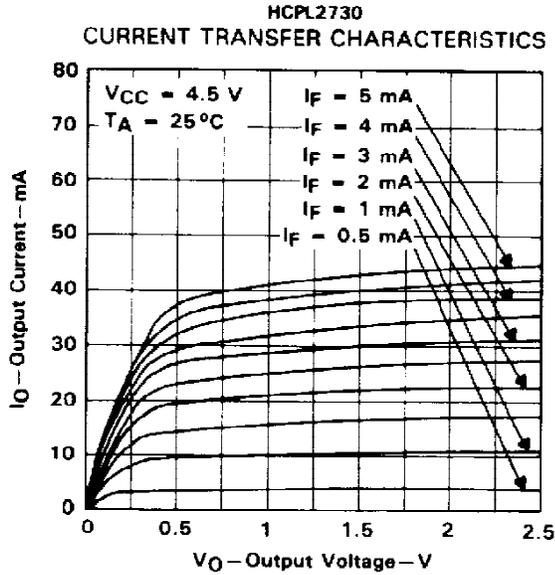
NOTE A: In applications where dV/dt may exceed $50,000 \text{ V}/\mu\text{s}$ (such as static discharge) a series resistor, R_{CC} , should be included to protect the detector IC from destructively high surge currents. The recommended value is:

$$R_{CC} = \frac{1}{0.15 I_F (\text{mA})} \text{ k}\Omega$$

FIGURE 2. TRANSIENT IMMUNITY TEST CIRCUIT AND WAVEFORMS

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TYPICAL CHARACTERISTICS



HCPL2730, HCPL2731
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TYPICAL CHARACTERISTICS

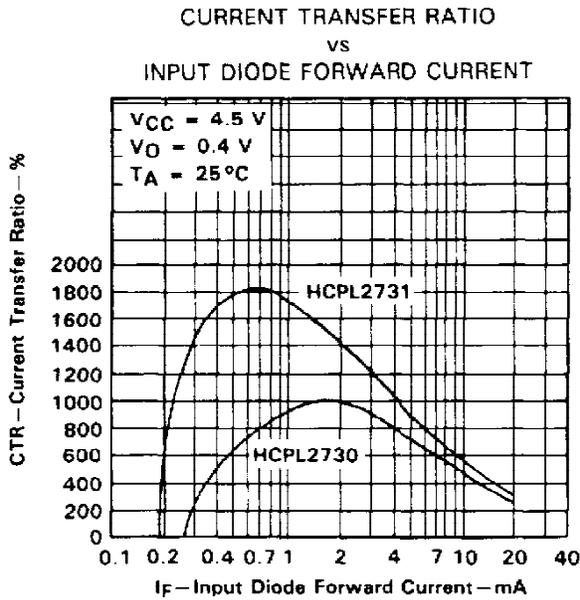


FIGURE 7

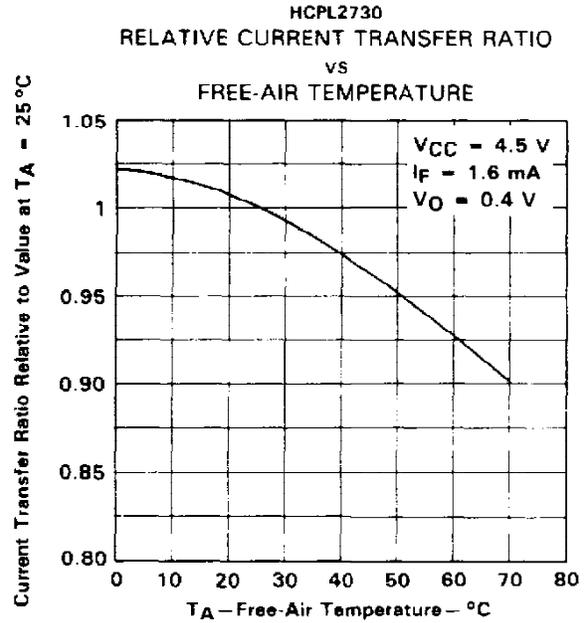


FIGURE 8

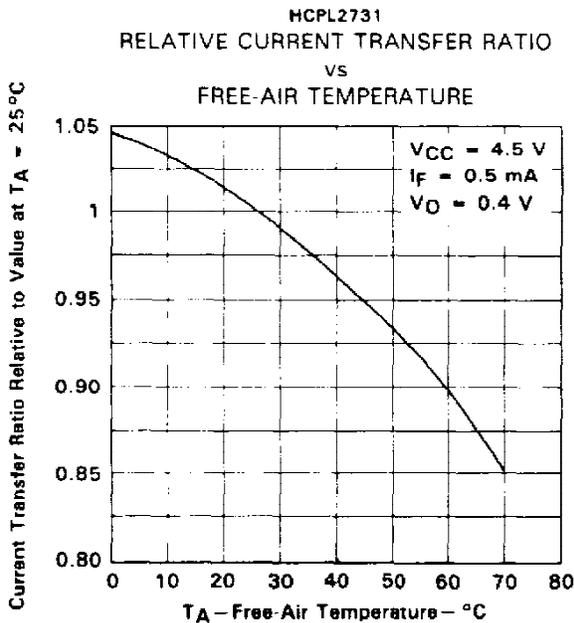


FIGURE 9

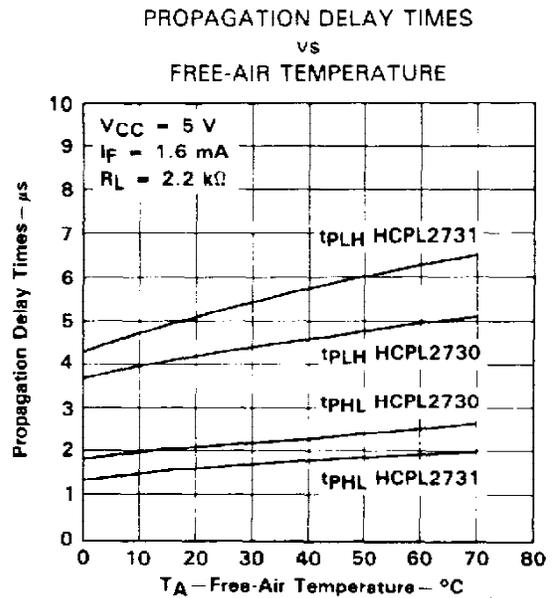


FIGURE 10

**HCPL2730, HCPL2731
DUAL-CHANNEL OPTOCOUPPLERS/OPTOISOLATORS**

TYPICAL CHARACTERISTICS

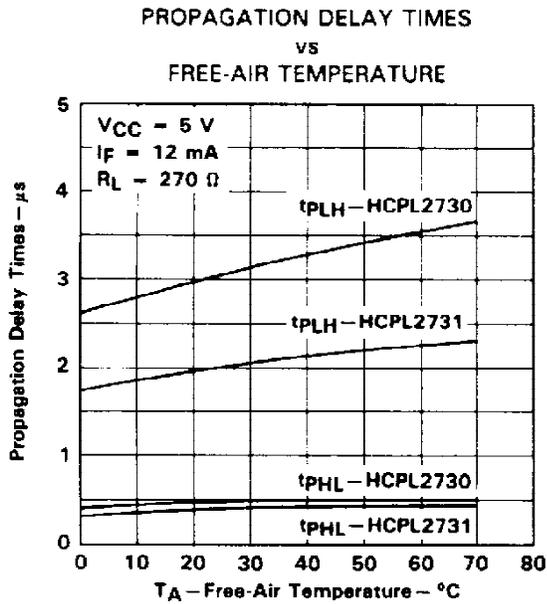


FIGURE 11

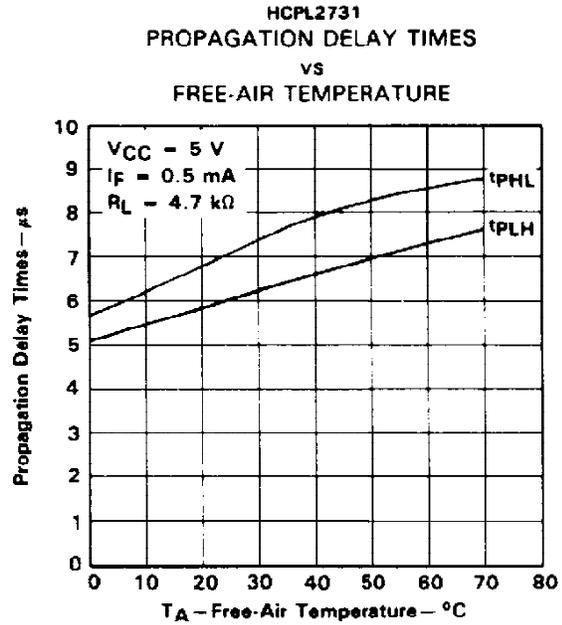


FIGURE 12

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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
HCPL2730	OBSOLETE	PDIP	N	8		TBD	Call TI	Call TI
HCPL2731	OBSOLETE	PDIP	N	8		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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